



Description

JMT P-channel Enhancement Mode Power MOSFET

Features

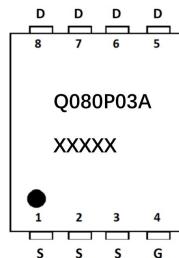
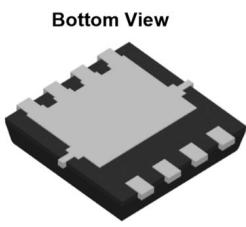
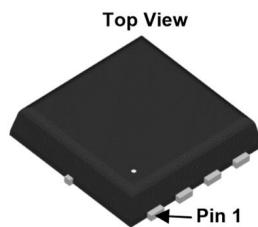
- $V_{DS} = -30V$, $I_D = -45A$
- $R_{DS(ON)} < 7.3m\Omega$ @ $V_{GS} = -10V$
- $R_{DS(ON)} < 11.7m\Omega$ @ $V_{GS} = -4.5V$
- Advanced Trench Technology
- Excellent $R_{DS(ON)}$ and Low Gate Charge
- Lead Free

Application

- PWM Applications
- Load Switch
- Power Management

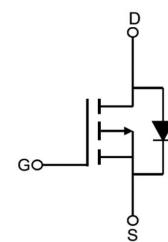


100% UIS TESTED!
100% ΔV_{ds} TESTED!



PDFN3x3-8L

Marking and pin Assignment



Schematic Diagram

Package Marking and Ordering Information

| Device Marking | Device | Outline | Package | Reel Size | Reel (pcs) | Per Carton (pcs) |
|----------------|-------------|---------|------------|-----------|------------|------------------|
| Q080P03A | JMTQ080P03A | TAPING | PDFN3x3-8L | 13" | 5000 | 50000 |

Absolute Maximum Ratings ($T_C=25^\circ C$ unless otherwise specified)

| Symbol | Parameter | | Max. | Units |
|-------------------|---|---------------------|-------------|--------------|
| V_{DSS} | Drain-Source Voltage | | -30 | V |
| V_{GSS} | Gate-Source Voltage | | ± 20 | V |
| I_D | Continuous Drain Current | $T_C = 25^\circ C$ | -45 | A |
| | | $T_C = 100^\circ C$ | -29 | A |
| I_{DM} | Pulsed Drain Current ^{note1} | | -180 | A |
| E_{AS} | Single Pulsed Avalanche Energy ^{note2} | | 196 | mJ |
| P_D | Power Dissipation | $T_C = 25^\circ C$ | 26 | W |
| $R_{\theta JC}$ | Thermal Resistance, Junction to Case | | 4.9 | $^\circ C/W$ |
| T_J , T_{STG} | Operating and Storage Temperature Range | | -55 to +150 | $^\circ C$ |

**Electrical Characteristics** ($T_J=25^\circ\text{C}$ unless otherwise specified)

| Symbol | Parameter | Test Condition | Min. | Typ. | Max. | Units |
|---|--|---|------|------|-----------|------------------|
| Off Characteristics | | | | | | |
| $V_{(\text{BR})\text{DSS}}$ | Drain-Source Breakdown Voltage | $V_{GS}=0\text{V}$, $I_D = -250\mu\text{A}$ | -30 | - | - | V |
| I_{DSS} | Zero Gate Voltage Drain Current | $V_{DS} = -30\text{V}$, $V_{GS}=0\text{V}$, | - | - | -1 | μA |
| I_{GSS} | Gate to Body Leakage Current | $V_{DS}=0\text{V}$, $V_{GS} = \pm 20\text{V}$ | - | - | ± 100 | nA |
| On Characteristics | | | | | | |
| $V_{GS(\text{th})}$ | Gate Threshold Voltage | $V_{DS}=V_{GS}$, $I_D = -250\mu\text{A}$ | -1.0 | -1.5 | -2.5 | V |
| $R_{DS(\text{on})}$ note3 | Static Drain-Source on-Resistance | $V_{GS} = -10\text{V}$, $I_D = -30\text{A}$ | - | 5.8 | 7.3 | $\text{m}\Omega$ |
| | | $V_{GS} = -4.5\text{V}$, $I_D = -20\text{A}$ | - | 9 | 11.7 | |
| Dynamic Characteristics | | | | | | |
| C_{iss} | Input Capacitance | $V_{DS} = -15\text{V}$, $V_{GS}=0\text{V}$, $f=1.0\text{MHz}$ | - | 4650 | - | pF |
| C_{oss} | Output Capacitance | | - | 550 | - | pF |
| C_{rss} | Reverse Transfer Capacitance | | - | 486 | - | pF |
| Q_g | Total Gate Charge | $V_{DD} = -15\text{V}$, $I_D = -20\text{A}$, $V_{GS} = -10\text{V}$ | - | 76 | - | nC |
| Q_{gs} | Gate-Source Charge | | - | 14 | - | nC |
| Q_{gd} | Gate-Drain("Miller") Charge | | - | 16 | - | nC |
| Switching Characteristics | | | | | | |
| $t_{d(on)}$ | Turn-on Delay Time | $V_{DD} = -15\text{V}$, $I_D = -30\text{A}$, $V_{GS} = -10\text{V}$, $R_{\text{GEN}} = 2.4\Omega$ | - | 12 | - | ns |
| t_r | Turn-on Rise Time | | - | 112 | - | ns |
| $t_{d(off)}$ | Turn-off Delay Time | | - | 82 | - | ns |
| t_f | Turn-off Fall Time | | - | 93 | - | ns |
| Drain-Source Diode Characteristics and Maximum Ratings | | | | | | |
| I_s | Maximum Continuous Drain to Source Diode Forward Current | - | - | -45 | A | |
| I_{SM} | Maximum Pulsed Drain to Source Diode Forward Current | - | - | -180 | A | |
| V_{SD} | Drain to Source Diode Forward Voltage | $V_{GS}=0\text{V}$, $I_s = -30\text{A}$ | - | -0.8 | -1.2 | V |

Notes:1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature

2. E_{AS} condition: Starting $T_J=25^\circ\text{C}$, $V_{DD} = -20\text{V}$, $V_{GS} = -10\text{V}$, $R_G=25\Omega$, $L=0.5\text{mH}$, $I_{AS} = -28\text{A}$

3. Pulse Test: Pulse Width≤300μs, Duty Cycle≤2%

Typical Performance Characteristics

Figure 1: Output Characteristics

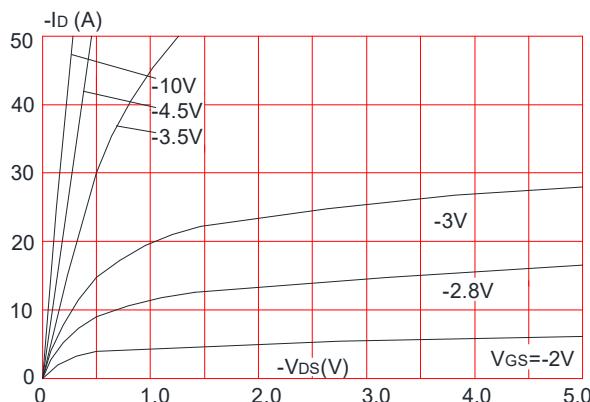


Figure 3: On-resistance vs. Drain Current

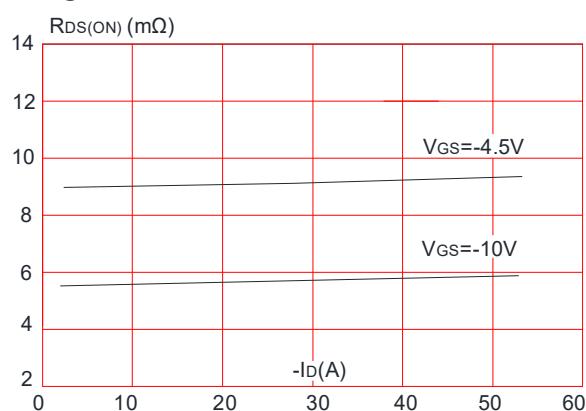


Figure 5: Gate Charge Characteristics

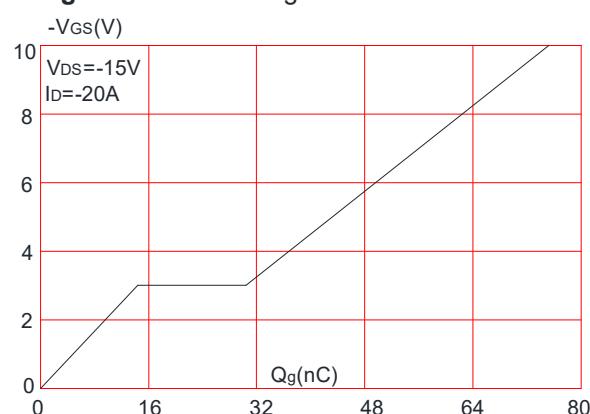


Figure 2: Typical Transfer Characteristics

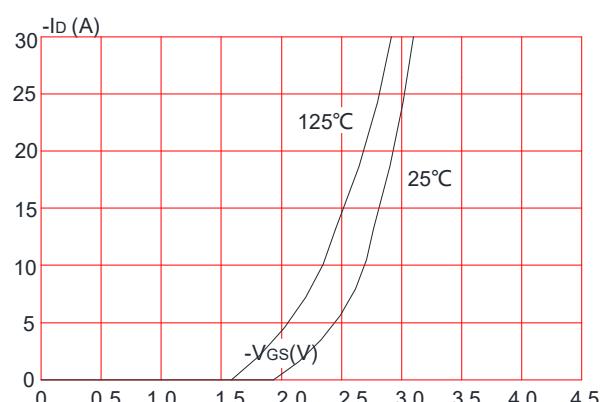


Figure 4: Body Diode Characteristics

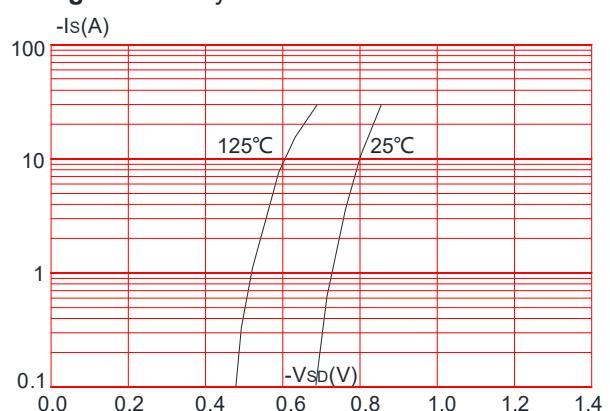


Figure 6: Capacitance Characteristics

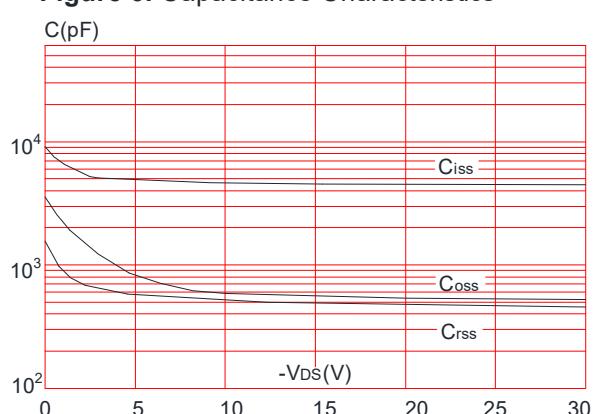


Figure 7: Normalized Breakdown Voltage vs. Junction Temperature

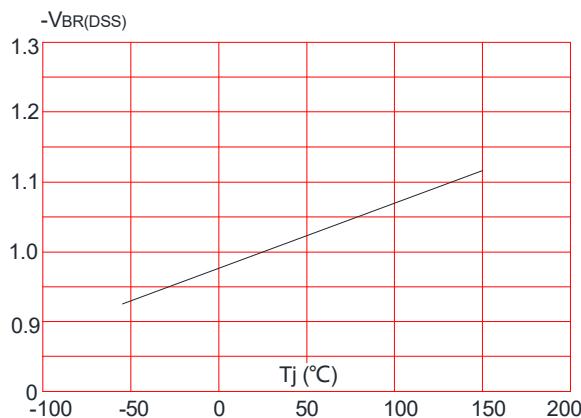


Figure 9: Maximum Safe Operating Area

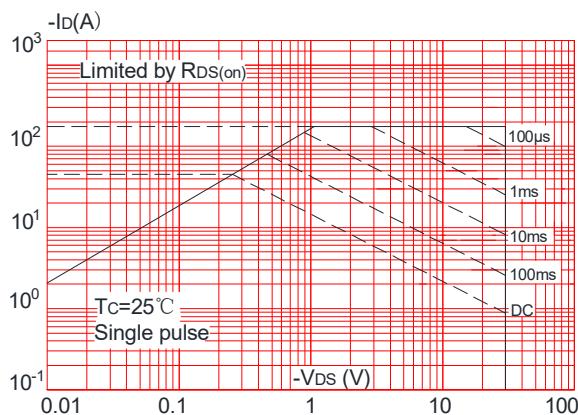


Figure 11: Maximum Effective Transient Thermal Impedance, Junction-to-Case

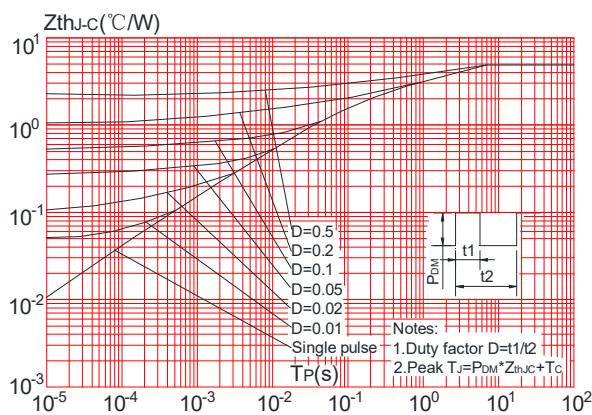


Figure 8: Normalized on Resistance vs. Junction Temperature

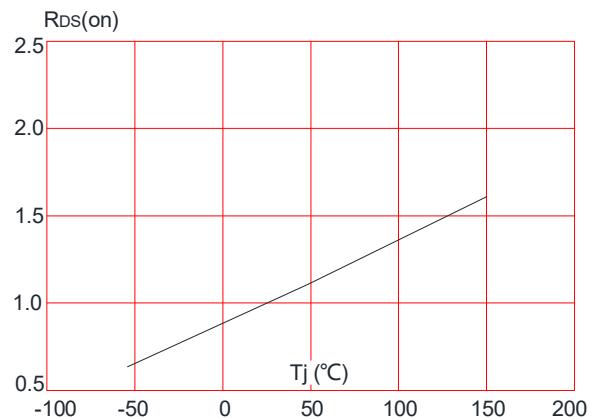
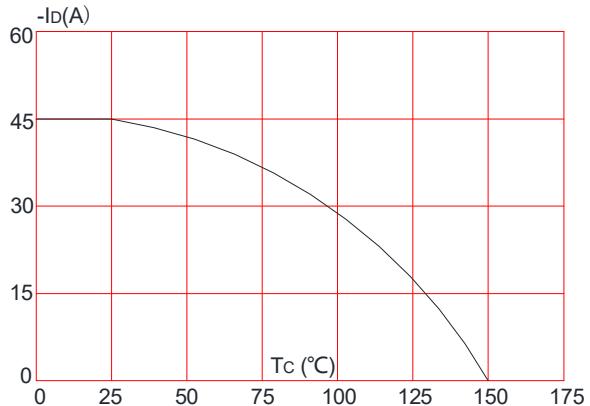
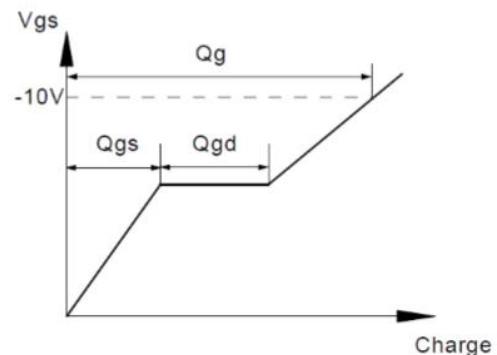
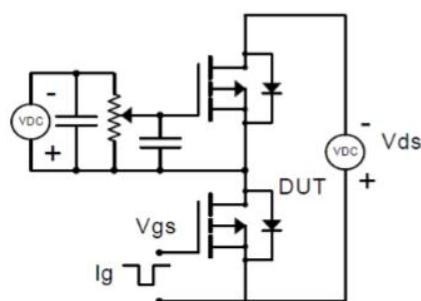


Figure 10: Maximum Continuous Drain Current vs. Case Temperature

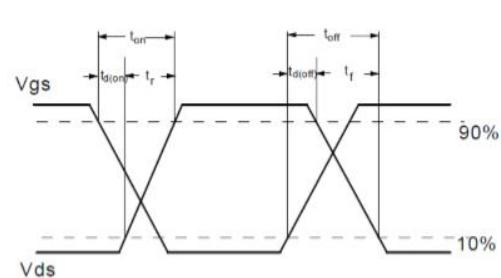
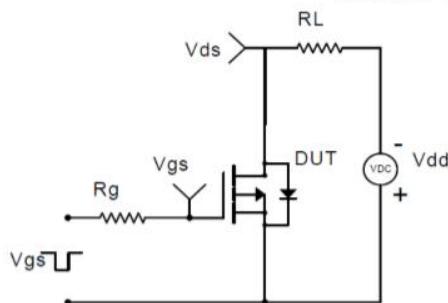


Test Circuit

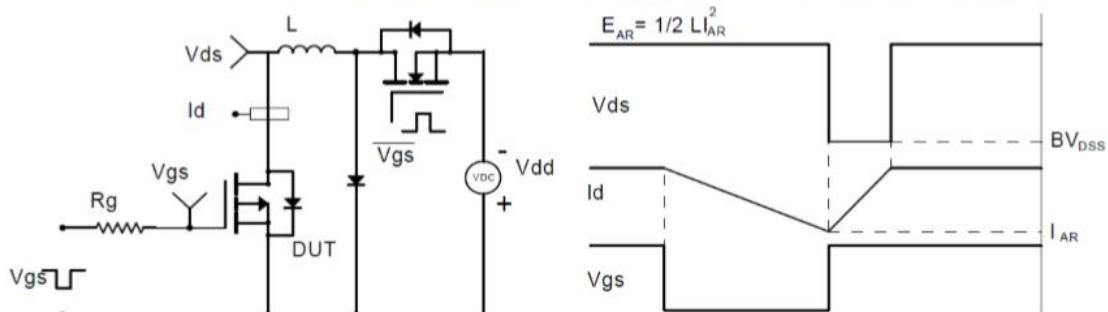
Gate Charge Test Circuit & Waveform



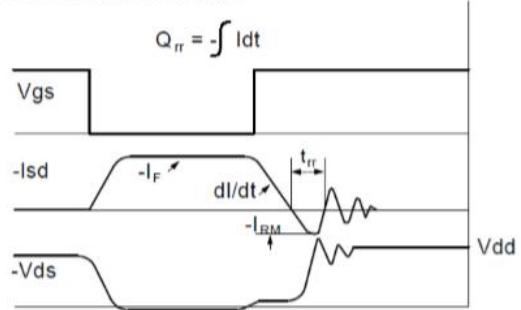
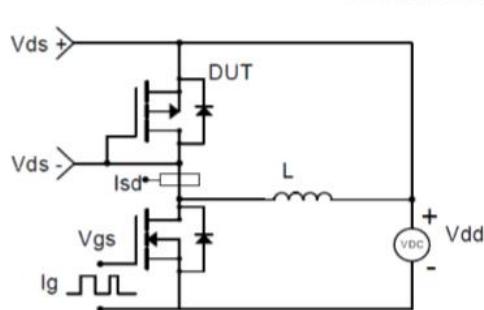
Resistive Switching Test Circuit & Waveforms



Unclamped Inductive Switching (UIS) Test Circuit & Waveforms

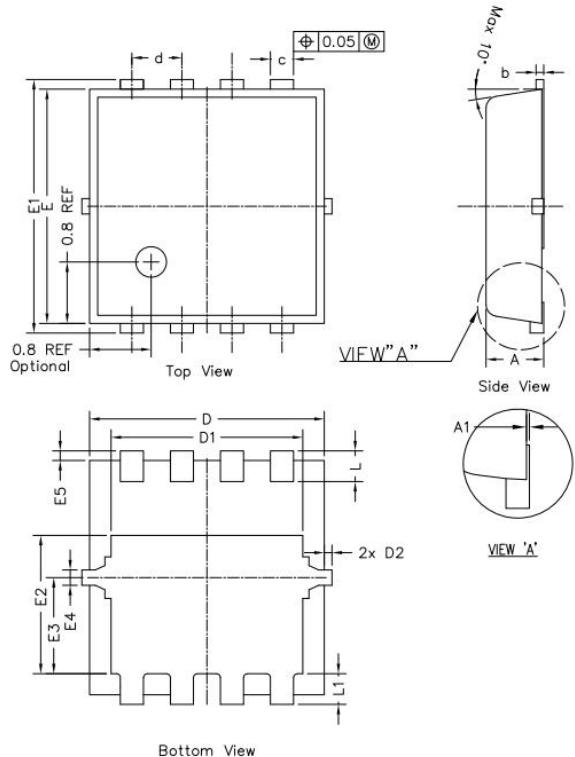


Diode Recovery Test Circuit & Waveforms





Package Mechanical Data- PDFN3x3-8L



| SYMBOLS | DIMENSION IN MM | | | DIMENSION IN INCHES | | |
|---------|-----------------|-------|-------|---------------------|-------|-------|
| | MIN | NOM | MAX | MIN | NOM | MAX |
| A | 0.700 | 0.750 | 0.800 | 0.028 | 0.030 | 0.031 |
| A1 | --- | --- | 0.050 | ---- | ---- | 0.002 |
| b | 0.144 | 0.152 | 0.202 | 0.006 | 0.006 | 0.008 |
| c | 0.250 | 0.300 | 0.350 | 0.010 | 0.012 | 0.014 |
| d | 0.65 BSC | | | 0.026 BSC | | |
| D | 2.950 | 3.050 | 3.150 | 0.116 | 0.120 | 0.124 |
| D1 | 2.390 | 2.490 | 2.590 | 0.094 | 0.098 | 0.102 |
| D2 | --- | --- | 0.125 | --- | --- | 0.005 |
| E | 2.950 | 3.050 | 3.150 | 0.116 | 0.120 | 0.124 |
| E1 | 3.200 | 3.300 | 3.400 | 0.126 | 0.130 | 0.134 |
| E2 | 1.700 | 1.800 | 1.900 | 0.067 | 0.071 | 0.075 |
| E3 | 1.150 | 1.250 | 1.350 | 0.045 | 0.049 | 0.053 |
| E4 | 0.150 | 0.200 | 0.250 | 0.006 | 0.008 | 0.010 |
| E5 | 0.075 | 0.125 | 0.175 | 0.003 | 0.005 | 0.007 |
| L | 0.300 | 0.400 | 0.500 | 0.01 | 0.02 | 0.02 |
| L1 | 0.300 | 0.400 | 0.500 | 0.01 | 0.02 | 0.02 |

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